

2nd EIC Yellow Report Workshop
Pavia University (held online), 20-22 May 2020

Parallel session
Calorimeter & Particle ID & Tracking

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for the Tracking WG

Ongoing activities and available results

Ongoing activities:

- working on the following main deliverables:
 - ✓ evaluate all-silicon vs hybrid (silicon & gaseous) trackers
 - ✓ compare realistic alternatives (TPC, MPGD options) for gaseous detectors, barrel and forward
- preliminary performance studies (mainly EicRoot-based simulations):
 - ✓ central region Si-vertex + TPC + Fast MPGD Layers **advanced**
 - ✓ Cylindrical Micromegas (MPGDs) **just started**
 - ✓ endcap region GEM (MPGDs) trackers **just started**
 - ✓ all-silicon (barrel) tracker + forward/backward silicon disks **advanced**
 - ✓ comparisons all-silicon vs BeAST (Si-vertex + TPC + MPGDs) concepts **ongoing**
- effort on Fun4All and ESCalate frameworks:
 - ✓ first implementations of all-silicon tracker in Fun4All and G4E **ongoing**
 - ✓ plan to implement realistic material and services for all the tracking detectors **just started**

Available results:

- relative momentum and pointing resolutions (in different configurations and options)
- angular resolutions at DIRC (Si-vertex + TPC + Fast MPGDs different options)

Outline for today's discussion

Hybrid/gaseous detector options:

- central region Si-vertex + TPC + Fast MPGD Layers:
 - ✓ 3 options studied: no MPGDs + 2 different configurations with MPGDs before/behind DIRC
 - ✓ angular resolution before and behind DIRC position, relative momentum resolution
- cylindrical micromegas:
 - ✓ alternative to TPC, 2 different layer arrangements studied
 - ✓ Angular resolutions at DIRC position, relative momentum resolution
- material budget considerations
- pros/cons summary table

Silicon detector trackers:

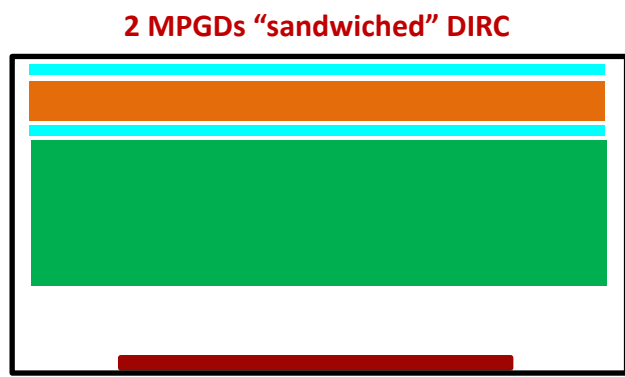
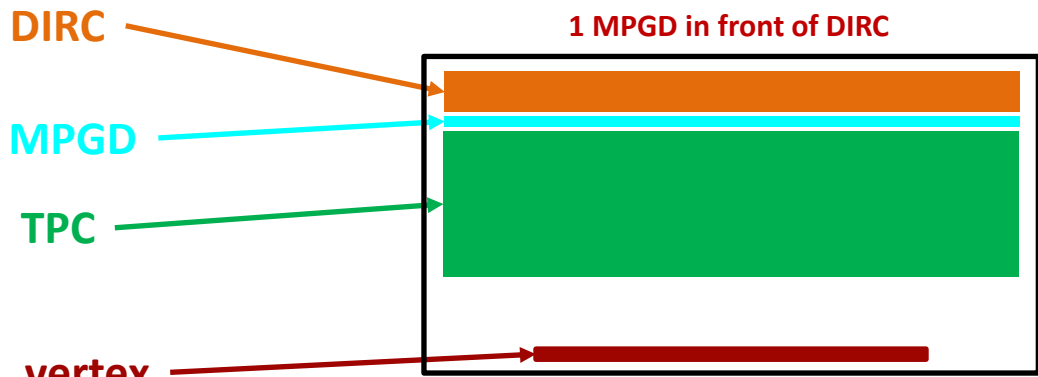
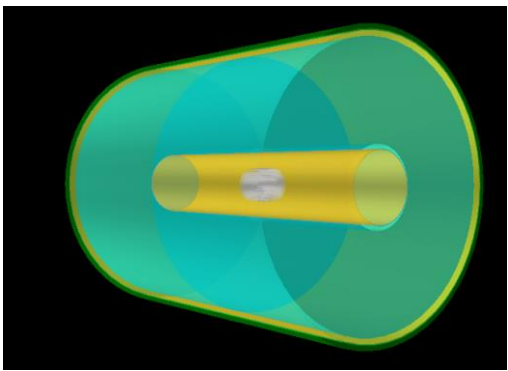
- all-silicon tracker option:
 - ✓ tapered all-silicon in Fun4All, first estimates of the angular resolutions
- all-silicon and Si+TPC tracker studies
- pros/cons all-Si vs hybrid trackers

Si-vertex + TPC + MPDGs

Matt Posik, for eRD6

Detector setup:

- Si-vertex tracker: 4 layers of $20\ \mu\text{m} \times 20\ \mu\text{m}$
- TPC: No distortion corrections, field cage and end cap materials included
 - Transvers Dispersion: $40\ \mu\text{m}/\sqrt{D}$
 - Transverse Resolution: $90\ \mu\text{m}$
 - Longitudinal Dispersion: $1\ \mu\text{m}/\sqrt{D}$
 - Longitudinal Resolution: $500\ \mu\text{m}$
- MPGDs in μTPC mode: $100\ \mu\text{m} \times 100\ \mu\text{m}$ ($\phi \times Z$)
- 3 configurations investigated
 - No MPGDs
 - One MPGD layer in front of DIRC
 - 2 MPGD layers sandwiching DIRC



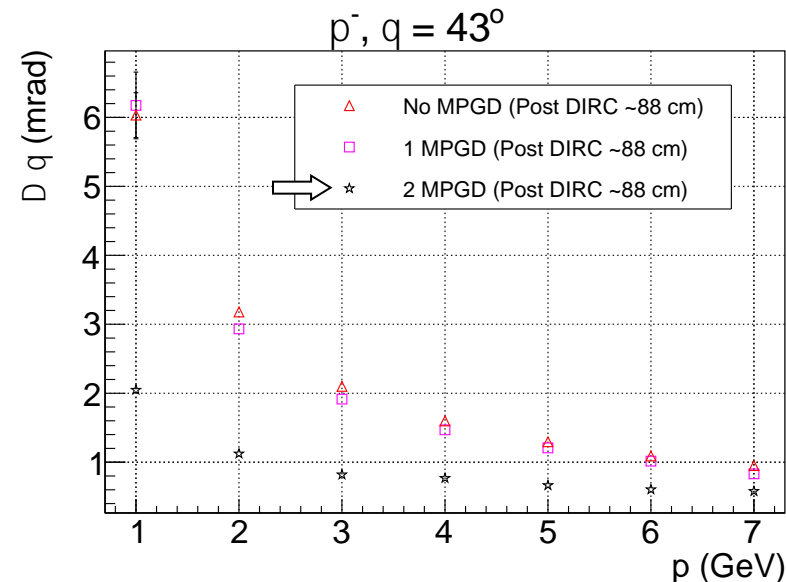
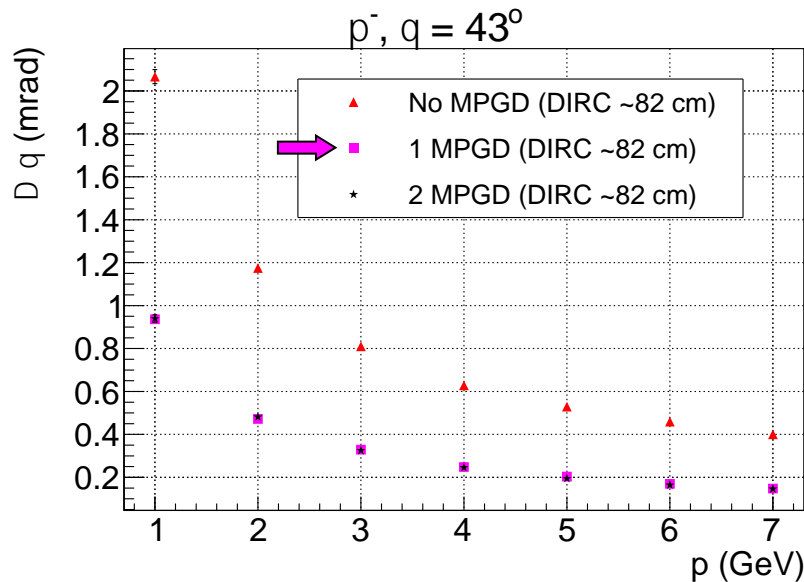
Tracking WG

Si-vertex + TPC + MPDGs

Matt Posik, for eRD6

Angular resolution $\Delta\theta$ before and after the DIRC:

- $B = 1.5$ T,
- Solid Markers: At DIRC (~ 82 cm)
- Open Markers: Behind DIRC (~ 88 cm)
- Significant improvement seen in angular resolution behind the DIRC with MPGD layers sandwiching it
 - Angular resolution $\Delta\theta \sim 0.25$ mrad before DIRC

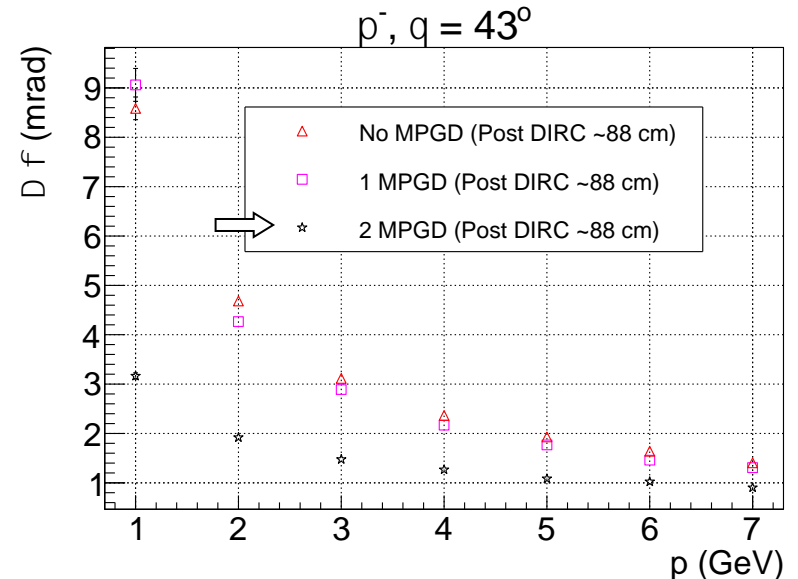
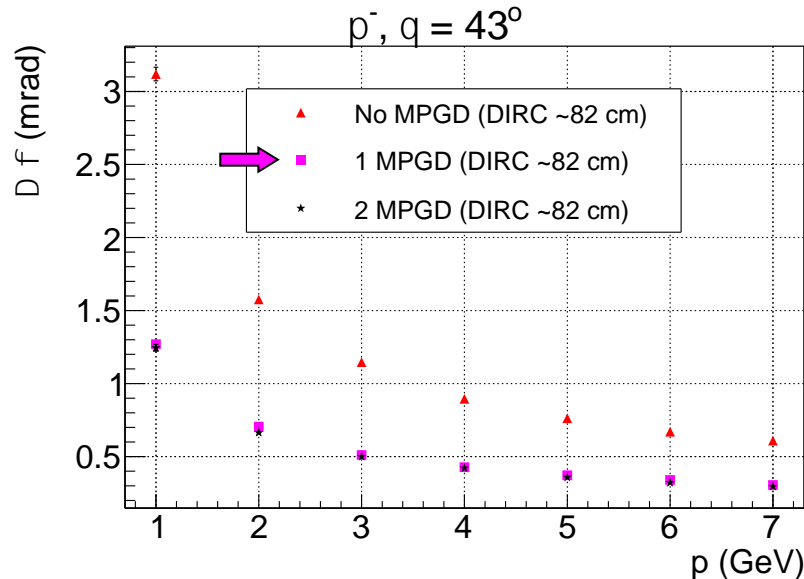


Si-vertex + TPC + MPDGs

Matt Posik, for eRD6

Angular resolution $\Delta\Phi$ before and after the DIRC:

- π^- , $B = 1.5$ T, $\theta = 43^\circ$
- Significant improvement seen in angular resolution behind the DIRC with MPGD layers surrounding the detector
 - Around 1 mrad $\Delta\phi$ resolution moderate p ($> \sim 5$ GeV).



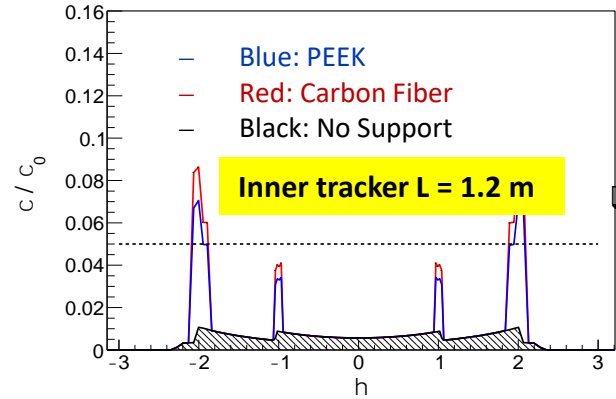
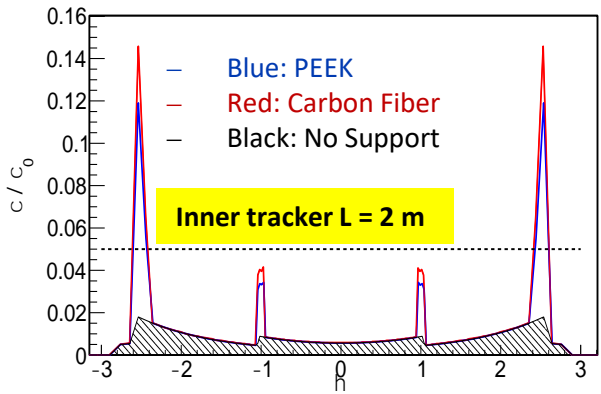
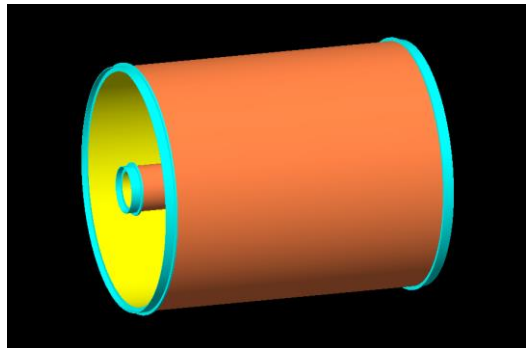
Si-vertex + TPC + MPDGs

Matt Posik, for eRD6

Material budget

- ❑ Detector configuration; Fast layers in barrel region
 - Outer μ RWell layer: L=2 m; radius = 80.0 cm
 - Inner μ RWell layer: L = 1.2 m; radius = 12.5 cm
- ❑ Support Ring Structure Geometry
 - Tube: thickness = 0.5 cm, length = 7.2 cm
 - Ring (inner): thickness = 1.6 cm, length = 1.2 cm
 - Ring (outer): thickness = 0.5 cm, length = 1.2 cm

Mock prototype (support ring)



- ❑ Next Steps Implement
 - supports every ~ 50 cm
 - Readout card material & endcap

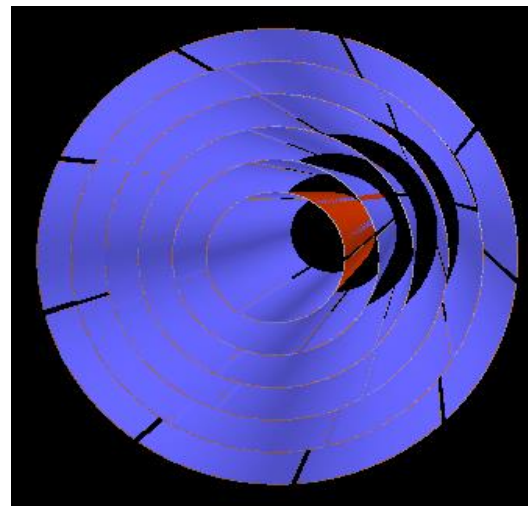
Cylindrical Micromegas

- Barrel MPGD tracker as TPC alternative:
 - Curved MPGD tiles with low material budget
 - Micromegas technology is being used in CLAS12
 - Possibly readout 2D coordinates on a single layer
- Simulation and performance study are under the ePhenix context
 - ePhenix TPC is replaced with the tracker
 - R is from 20 to 80cm, 2 tracker configs are studied



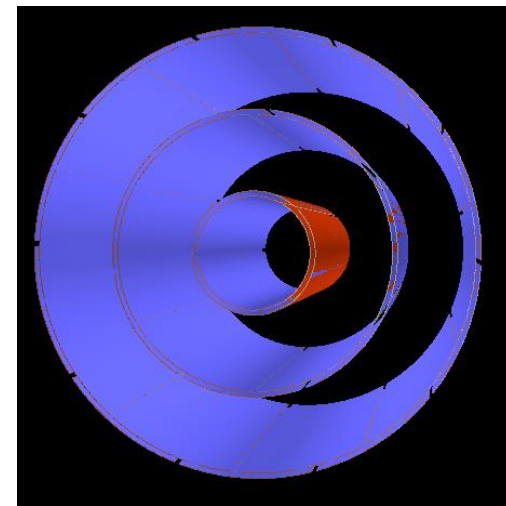
$X/X_0 \sim 0.3\%$ per layer

Tracking WG



6 equidistant layers

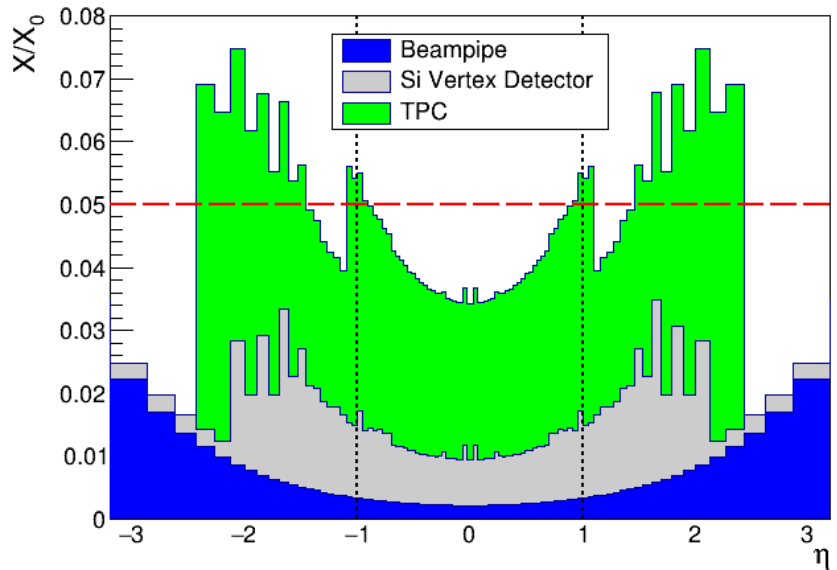
2nd EIC-YR Workshop / Pavia University / 20-22.5.2020



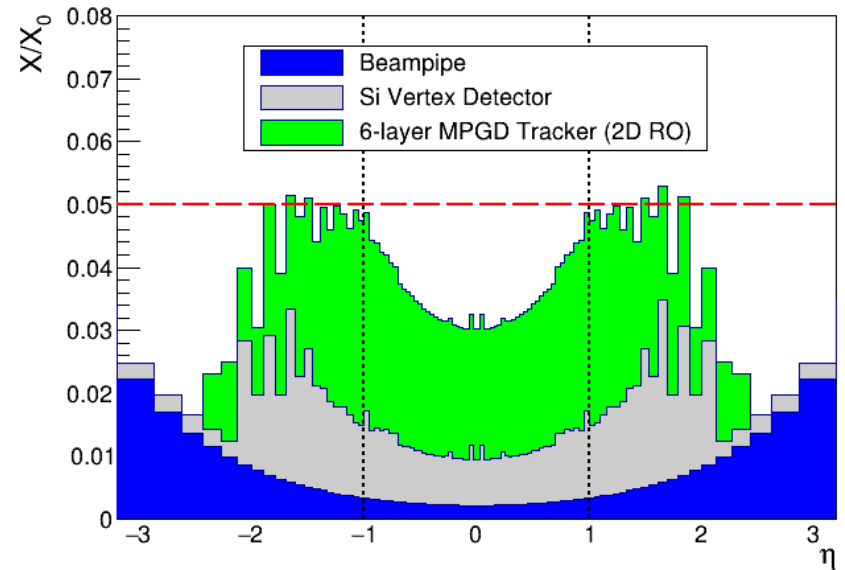
6 layers arranged as 3x2

- Compare material budget for TPC and 2D readout MPGD trackers
- Both TPC and 2D readout MPGD tracker are compatible with the requirement that $X/X_0 < 5\%$ for central tracker

TPC

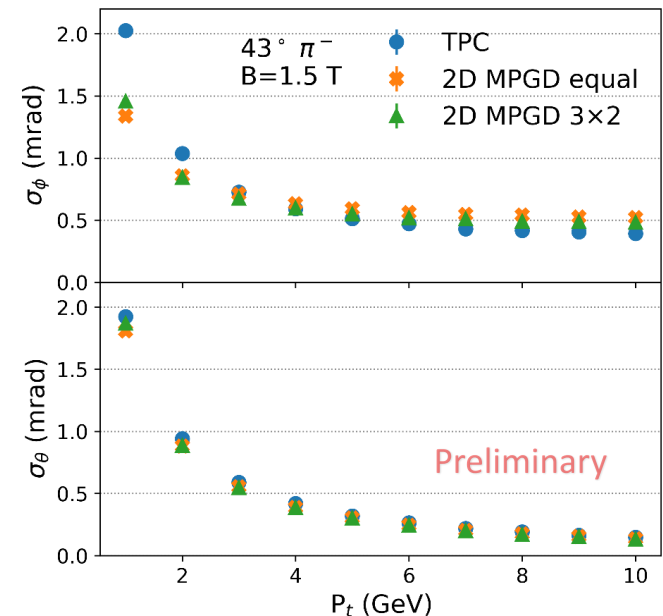
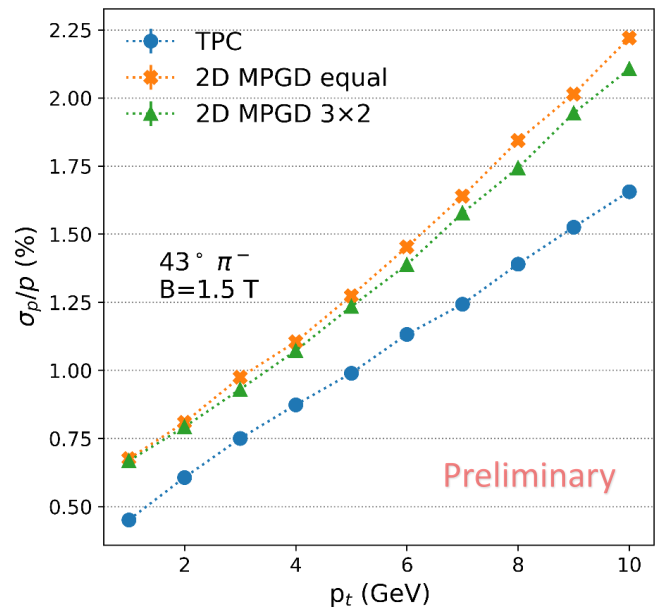


6-layer 2D RO MPGD tracker



Cylindrical Micromegas

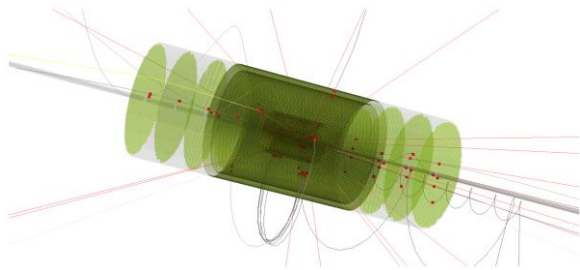
- Compare momentum/angular resolutions at DIRC ($r=81.5\text{cm}$) of different configs
 - Each point contains 10k π^- shot from (0,0,0) and with a constant $\theta=43^\circ$
 - Track reconstruction includes SVTX measurements: $\sigma(R/\phi/Z)=5\mu\text{m}$
 - For TPC: $\sigma(\phi)=200\mu\text{m}$, $\sigma(Z)=500\mu\text{m}$
 - For MPGD: $\sigma(\phi)=150\mu\text{m}$, $\sigma(Z)=150\mu\text{m}$
- Vigorous R&D ongoing at CEA Saclay to verify a potential improvement of the performance with micro-TPC mode



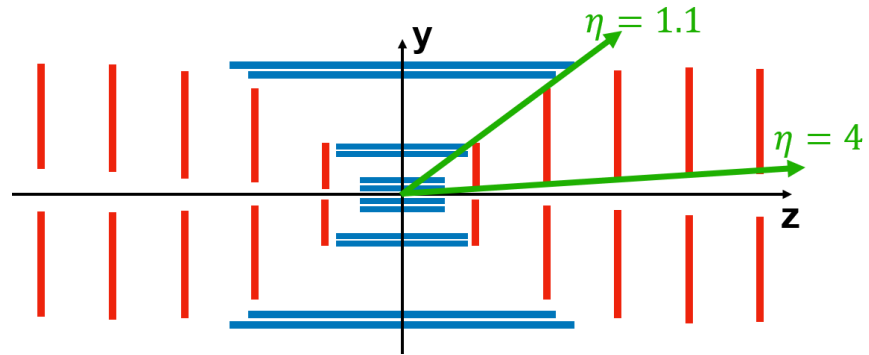
Gaseous Detectors: technology input for complementarity

	TPC + Fast MPGD Layer	Cylindrical MPGD (Micromegas, μ RWELL)	Drift Chambers / Straw Tubes	Planar MPGDs (GEM, Micromegas, μ RWELL)	Small TGCs	MPGD-TRDs
Barrel region	<u>Pros:</u> - momentum res.; - additional dE/dx; - cost - Low material in barrel	<u>Pros:</u> - Space point & angular res. - Time resolution (< 10 ns) - Low material in End cap - Cost & robustness	<u>Pros:</u> - momentum res.; - additional dE/dx; - cost - Low material in barrel	<u>Pros:</u> - Alternative to cylindrical MPGDs arrangement in polygons - Easier fabrication	N/A	N/A Radiator size
	<u>Cons:</u> - End cap material - calibration space charge distortion	<u>Cons:</u> - Momentum res. - Fabrication challenges - Material budget in barrel	<u>Cons:</u> - End cap material - calibration - Stability issues	<u>Cons:</u> - Momentum res. - Detector space barrel - Material budget in barrel		
Hadron End Cap	N/A Only planar option		<u>Pros:</u> - momentum res.; - additional dE/dx; - cost	<u>Pros:</u> - Momentum & angular res. - Low material (< 0.4% X/X0 per layer) - Cost & robustness	<u>Pros:</u> - Momentum & angular res. - Cost & robustness	<u>Pros:</u> - Additional tracking - Angular res. for RICH - Additional e/π PID
			<u>Cons:</u> - Material budget - calibration - Stability issues	<u>Cons:</u> - ?	<u>Cons:</u> - Material budget	<u>Cons:</u> - Radiator size
Electron End Cap	N/A Only planar option		N/A	<u>Pros:</u> - Momentum & angular res. - Low material (<0.4%) - Cost & robustness	N/A Mainly because of material budget	<u>Pros:</u> - Additional tracking - Complement main e PID in electron end cap
				<u>Cons:</u> - ?		<u>Cons:</u> - Radiator size?

All-silicon angular resolutions



Tapered All-Si Tracker in Fun4All



Functionality added by Chris Pinkenburg to project momenta onto cylinders or planes

Kalman Filter: PHG4TrackFastSim

Generation (~5M events):

vertex: (0,0,0)

momentum: (0,50 GeV/c)

$|\eta|$: (0,4)

ϕ : (0,2 π)

Additional parameters:

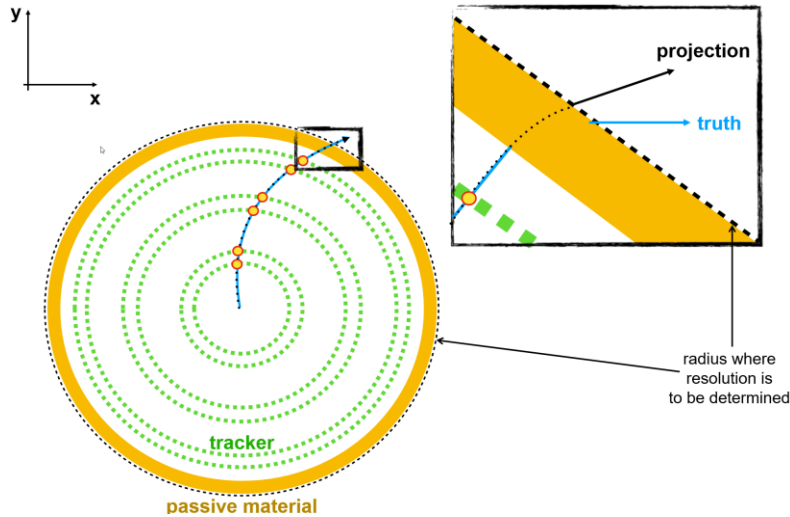
generated particle (π^+ , π^- , μ^- , e^-)

B field: 1.5, 3.0 T (solenoidal)

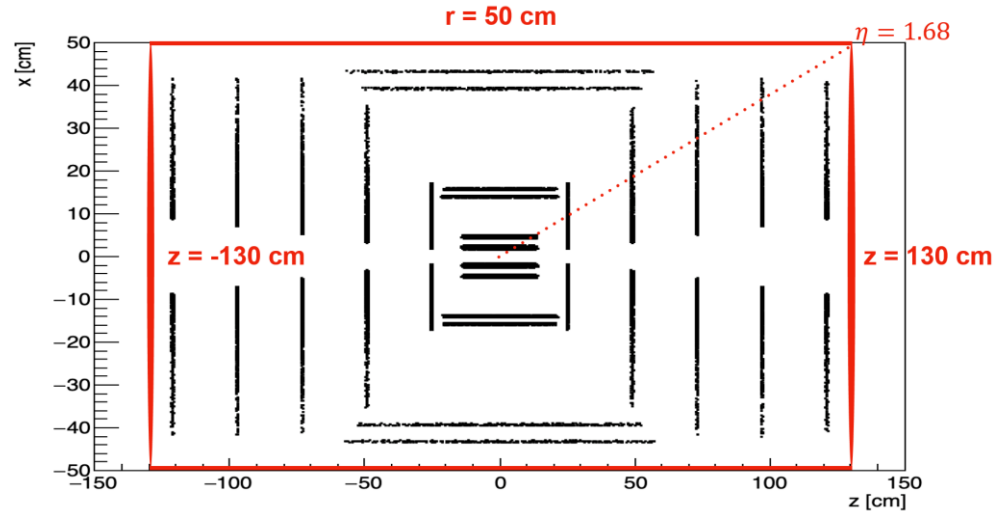
Only the silicon is implemented in the simulation

No support structure/services implemented

All silicon angular resolution



The tracking resolution is established by the projected track vs “truth” track

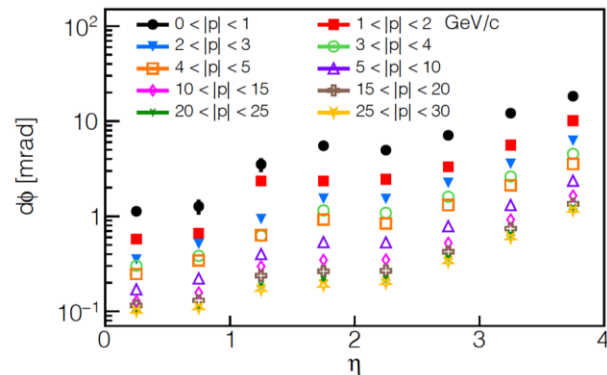
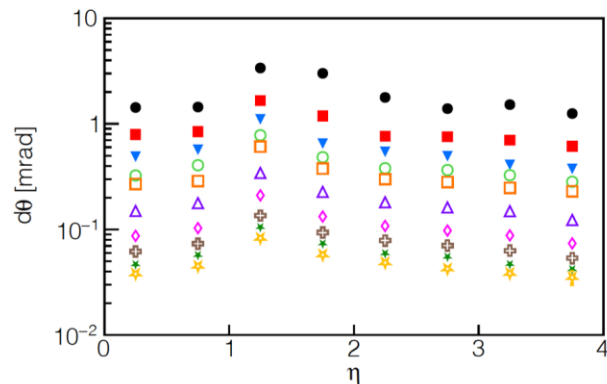
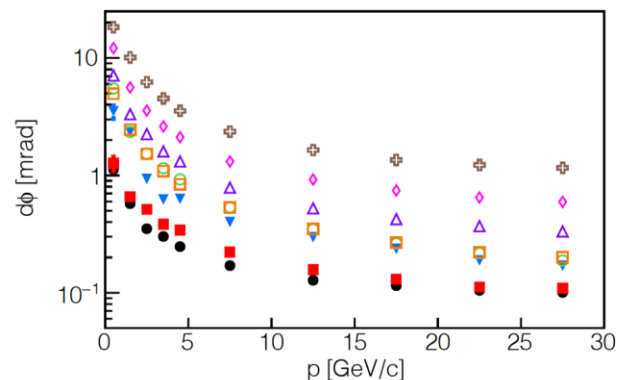
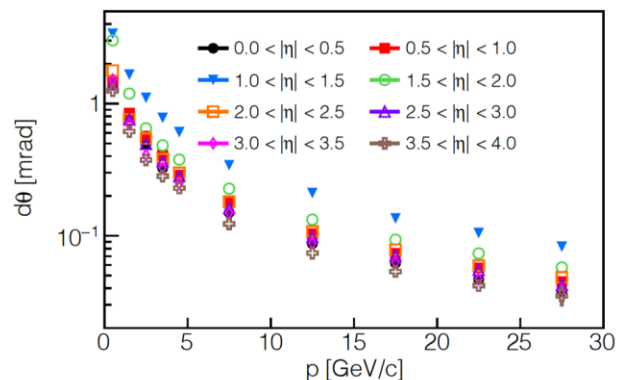


The angular resolution is shown on a cylindrical surface with the shown dimensions

Rey Cruz-Torres, Winston DeGraw - UCB

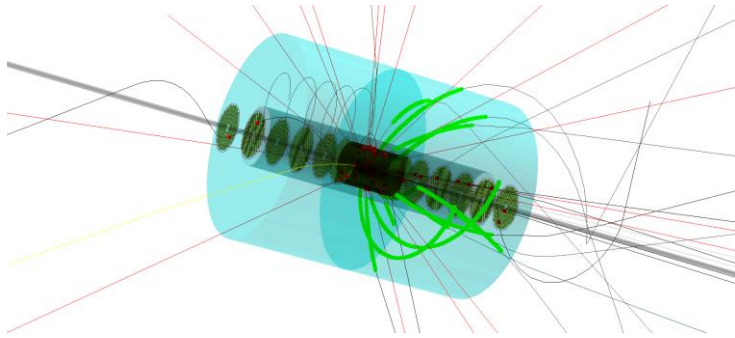
Angular resolutions on detector outer surface

e^- , $B = 3.0$ T

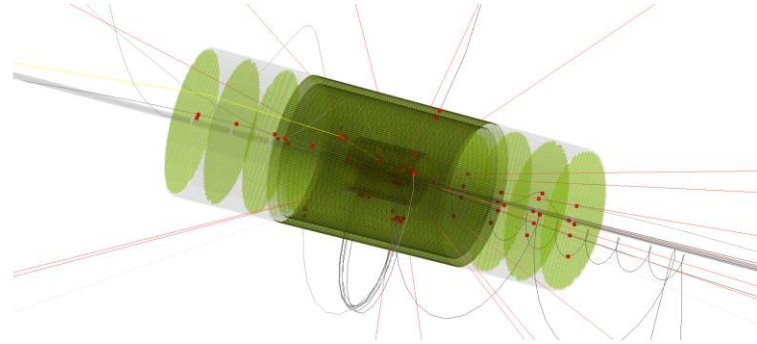


Rey Cruz-Torres, Winston DeGraw - UCB

All-silicon and Si+TPC studies



Beast TPC + Si barrels and disks (“hybrid”)



Si barrels and disks (“all silicon”)



All-silicon layout:

Two eRD18 vertex layers, seven eRD16 “tapered” equidistant disks in a BeAST configuration, and an ALICE-like outer barrel, in a 3T solenoidal field

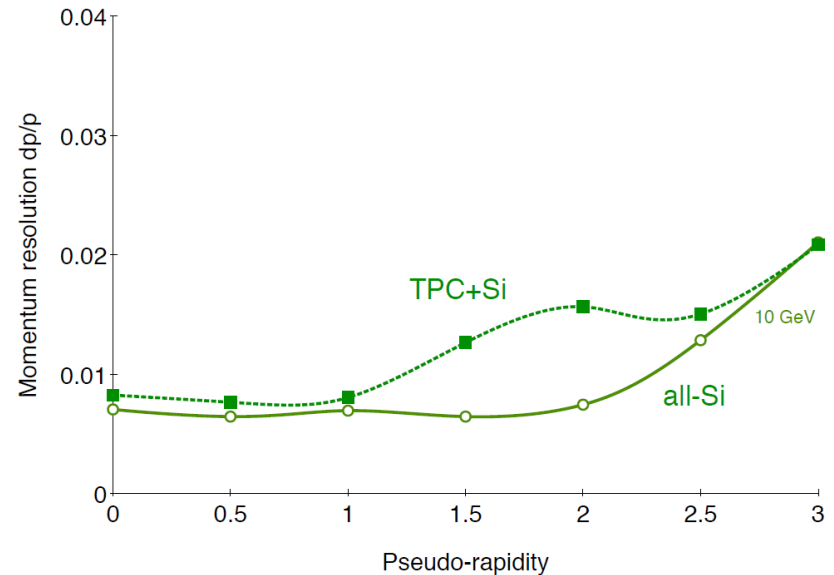
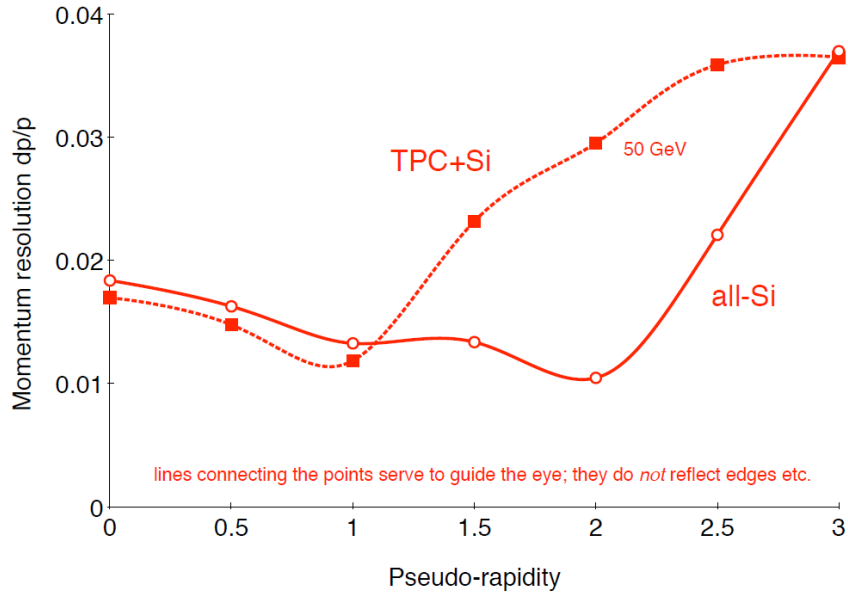
In addition:

Material cones/cylinders surrounding the disks were implemented to make a start on the effects associated with support structures, read-out infrastructure, etc.

Ernst Sichtermann et al, eRD16

All-silicon and Si+TPC studies

Momentum resolution as a function of pseudo-rapidity



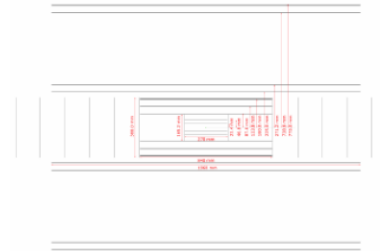
All-silicon and Si+TPC studies

- Various all-silicon layouts tested
- Parameters used:
 - Particle: e-
 - Momentum range: 0 to 50 GeV/c
 - Pseudorapidity range: $0 \leq \eta \leq 2.5$
 - Pixel size: $20 \times 20 \mu\text{m}^2$
 - Magnetic field: uniform 1.5 T
 - Layer thickness in “TPC replacement”: $0.8 \% X_0$

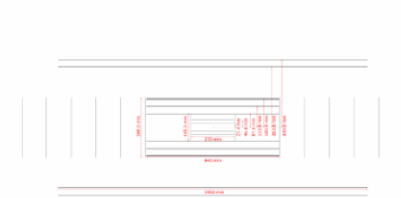


Key layouts and their aliases

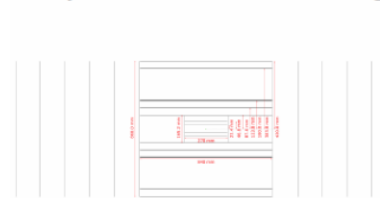
2+2 layers, long



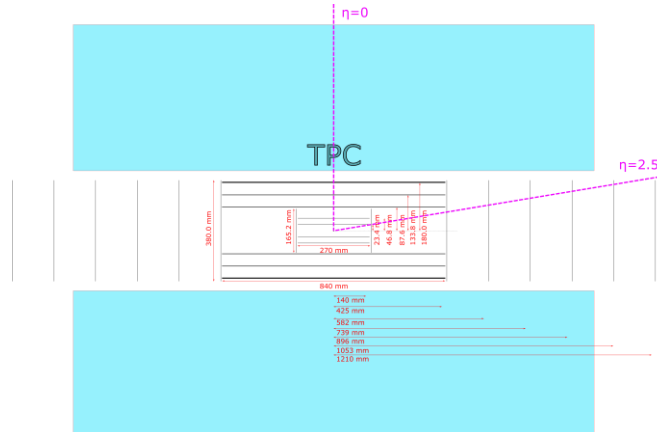
2 layers, long, small radius



2 layers, short, small radius, large disks

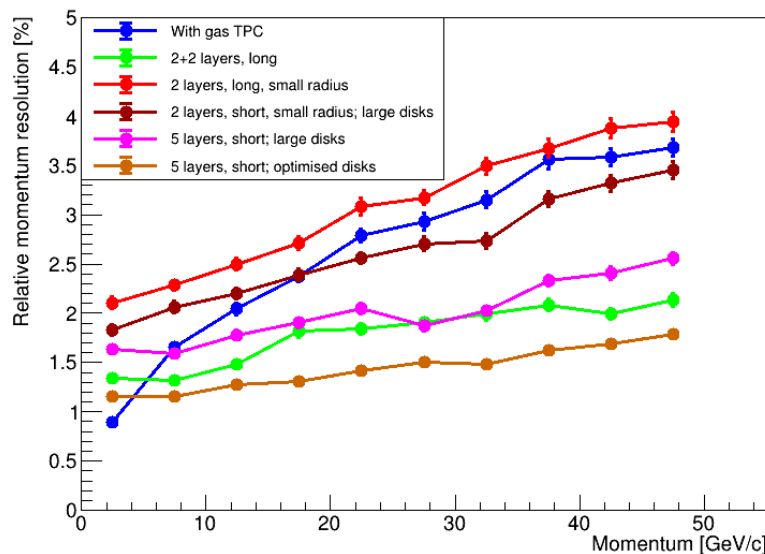


5 layers, short, optimised disks

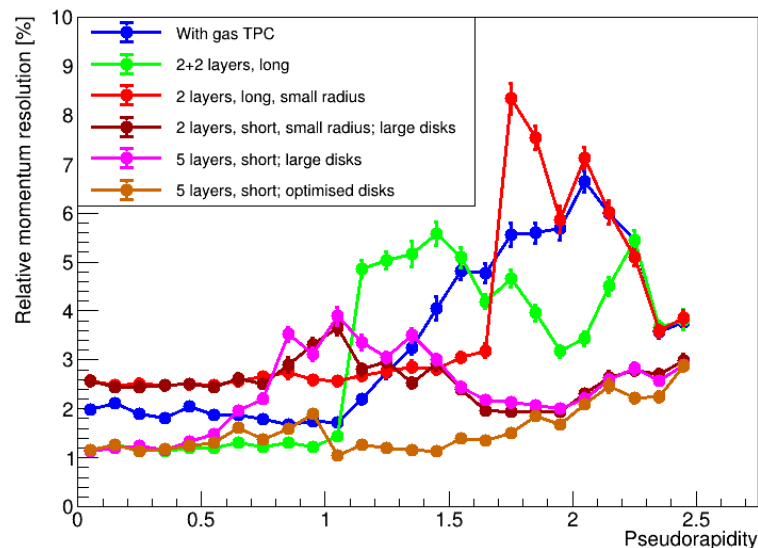


All-silicon and Si+TPC studies

Relative momentum resolution vs p



Relative momentum resolution vs η



- Large disk coverage is important to keep resolution at higher η
- All-silicon layout can outperform Si+TPC at $p \geq 5$ GeV/c
- Pointing resolutions do not change much between layouts, apart when layers are missed

Tracking WG: technology input for complementarity

Tracking Si central detector (vertex + barrel + discs)

Technology: for the vertex, barrel and inner disc detectors, the [only identified technology that meets the requirements are MAPS](#). No currently existing MAPS sensor appears to fully meet all of the EIC requirements (current simulations are based on ALPIDE sensors with a smaller pixel size 20 x 20 μm^2). In order to produce a new sensor design that meets the EIC requirements a consortium of EIC groups are joining an [ongoing sensor development effort at CERN](#). There are [contingency plans for modification of existing sensor designs to meet EIC requirements should this CERN effort be unsuccessful](#).

There is general consensus that this is a promising path to pursue to deliver an EIC sensor in the given timeframe. [Momentum and pointing resolution performance studies are in progress](#). EIC requirements seem [satisfied](#).

ITS3 silicon design parameters

Parameter	Wafer-scale sensor (this proposal)
Technology node	65 nm
Silicon thickness	20-40 μm
Pixel size	O(10 x 10 μm)
Chip dimensions	scalable up to 28 x 10 cm
Front-end pulse duration	~ 200 ns
Time resolution	< 100 ns (option: <10ns)
Max particle fluence	100 MHz/cm ²
Max particle readout rate	100 MHz/cm ²
Power Consumption	< 20 mW/cm ² (pixel matrix)
Detection efficiency	> 99%
Fake hit rate	< 10 ⁻⁷ event/pixel
NIEL radiation tolerance	10 ¹⁴ 1 MeV n _{eq} /cm ²
TID radiation tolerance	10 MRad

	Stave X/X0
ITS3 like vertexing	~0.1%
ITS3 like barrel (up to 1.5m length)	0.55 %
ITS3 like disc (up to 60 cm diameter)	0.24%

Si + gaseous detector vs. all silicon

	Si + gaseous	All Si
Attributes for consideration	<ul style="list-style-type: none"> dE/dx in gas for PID Well understood technology - less R&D needed. Costs less (likely) Less material in tracking region Worse single point resolution but more position samples 	<ul style="list-style-type: none"> Readout faster than TPC Better momentum resolution than TPC at higher momentum (>~5GeV/c) Can be made more compact Less material in endcap regions Fewer calibration/correction issues Very high single point resolution

backup

Implications of 31 mm radius beam pipe

Old beam pipe $r = 18$ mm, new beam pipe $r = 31$ mm

Tests done with 2 and 3 inner layers

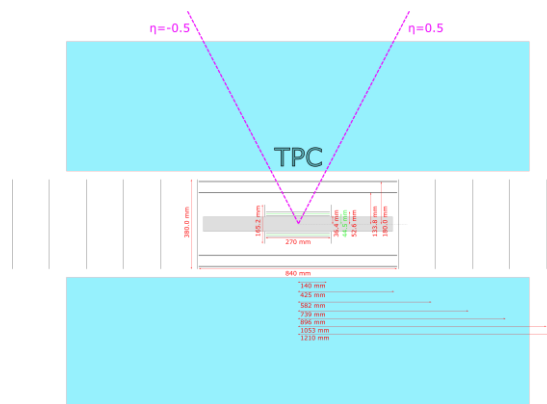
31 mm tests done with inner layers moved out, and new layout without time-stamping layer

Same TPC (EICROOT standard) always present

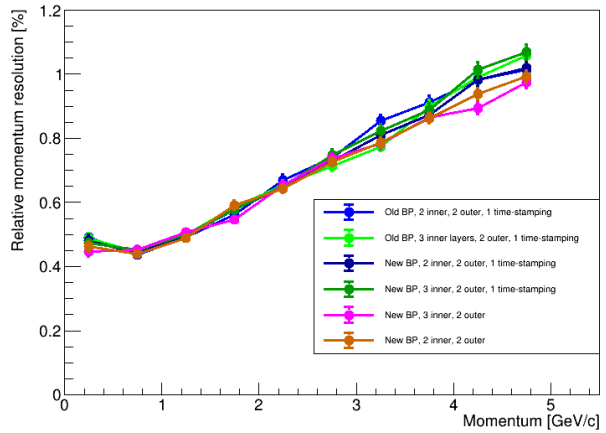
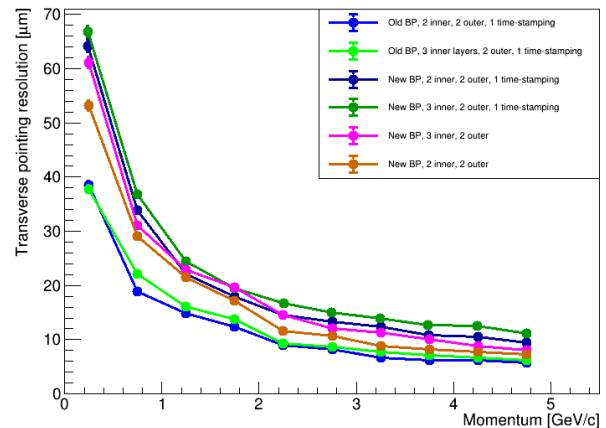
Parameters used:

π^+ , $P_t = 0$ to 5 GeV/c, $-0.5 \leq \eta \leq 0.5$, $20 \times 20 \mu\text{m}^2$, 0.3/0.8 %

X_0 inner/outer layers, 1.6 % time-stamping layer
uniform 1.5 T

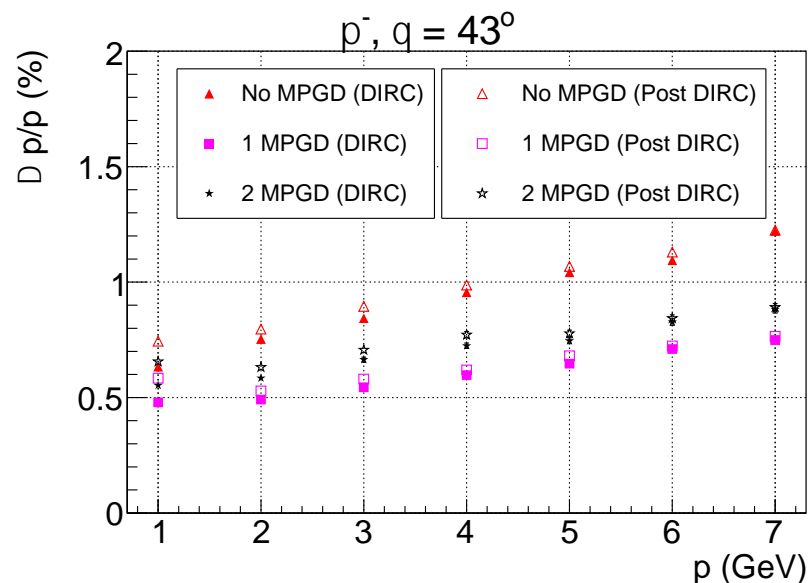


Some loss of pointing resolution at low momentum for larger beam pipe

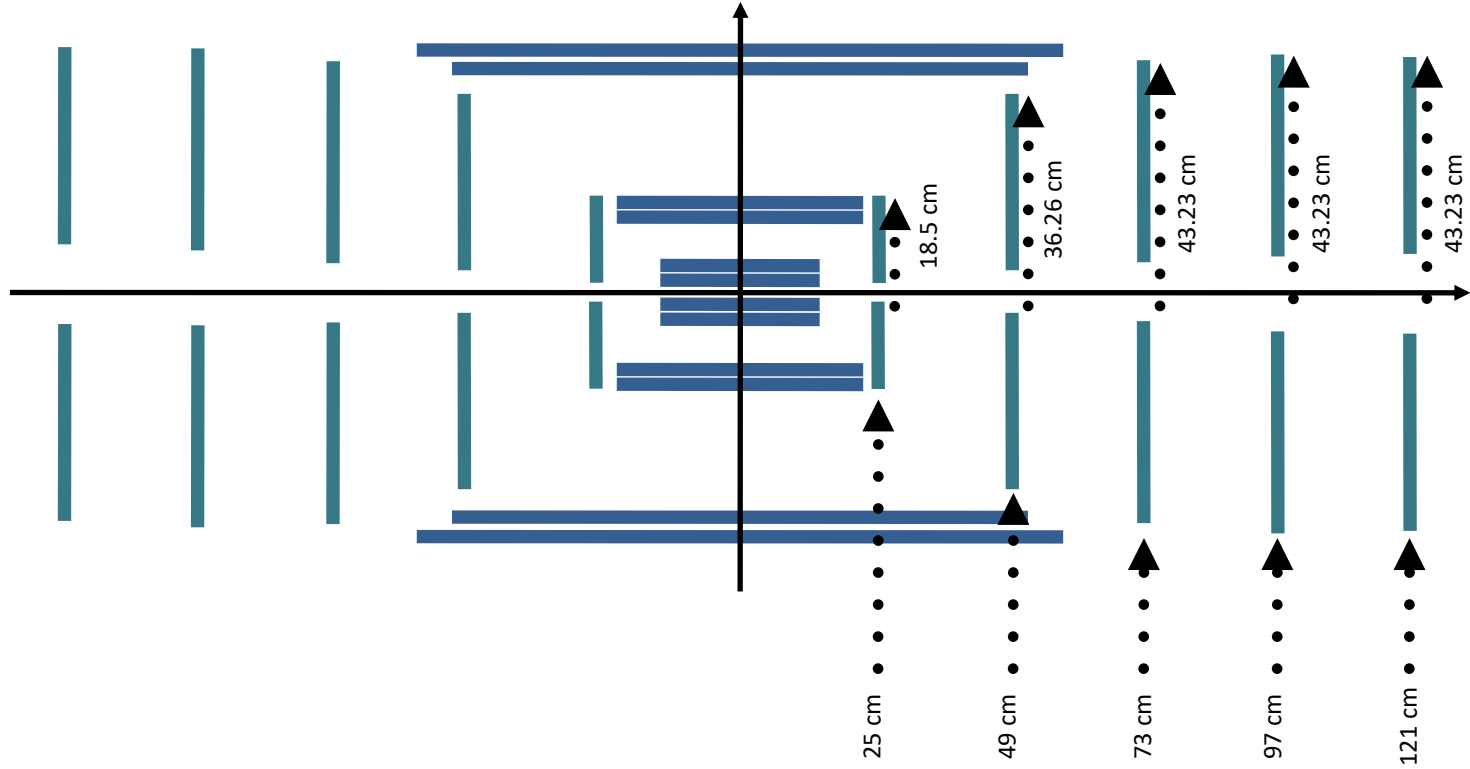


Relative momentum resolution:

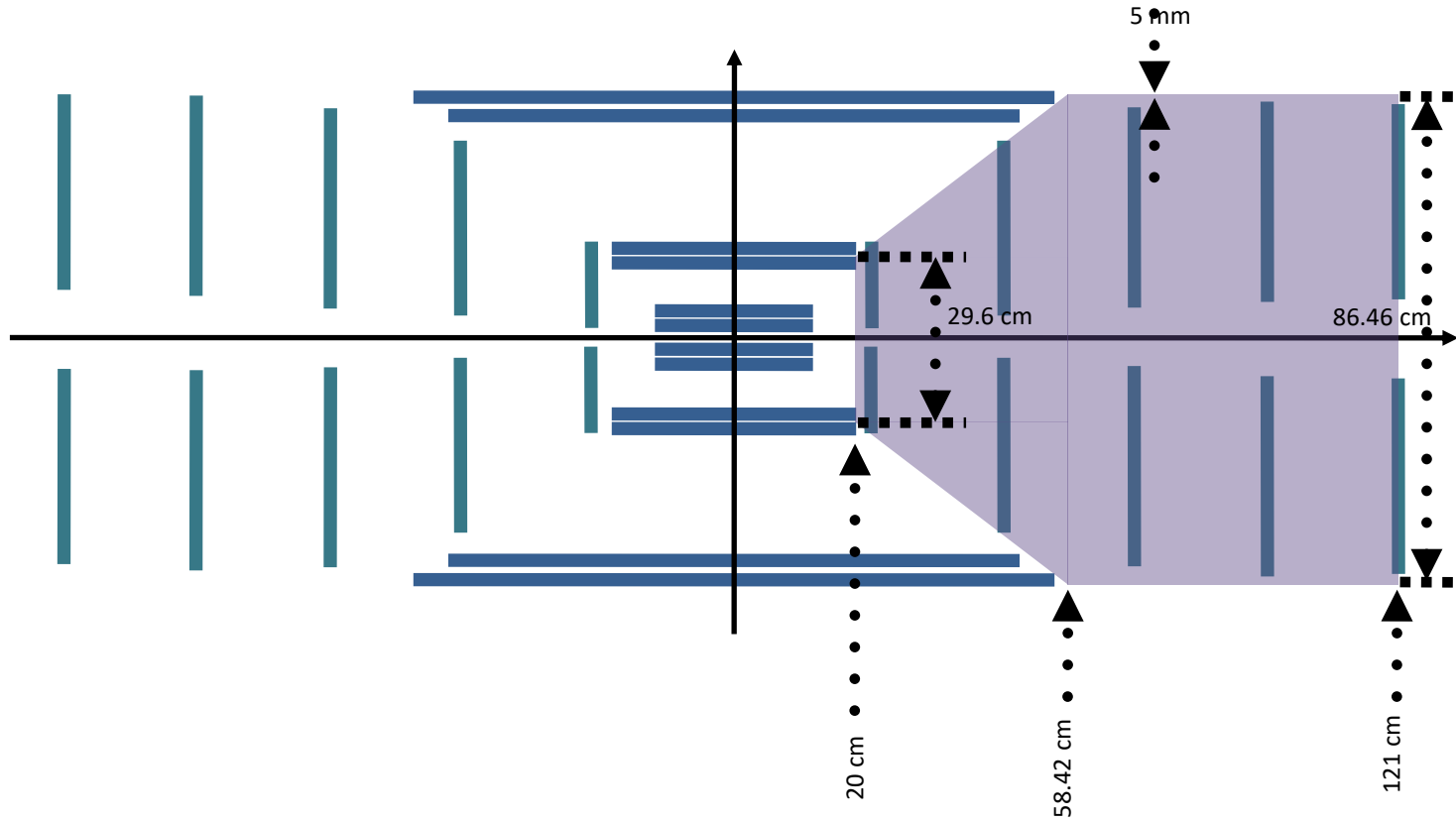
- One MPGD layer in front of DIRC significantly improves momentum resolution
- A second MPGD after DIRC slightly degrades performances because of multiple scattering in DIRC bar
 - However it is not really an issue as this data point is not needed for the momentum



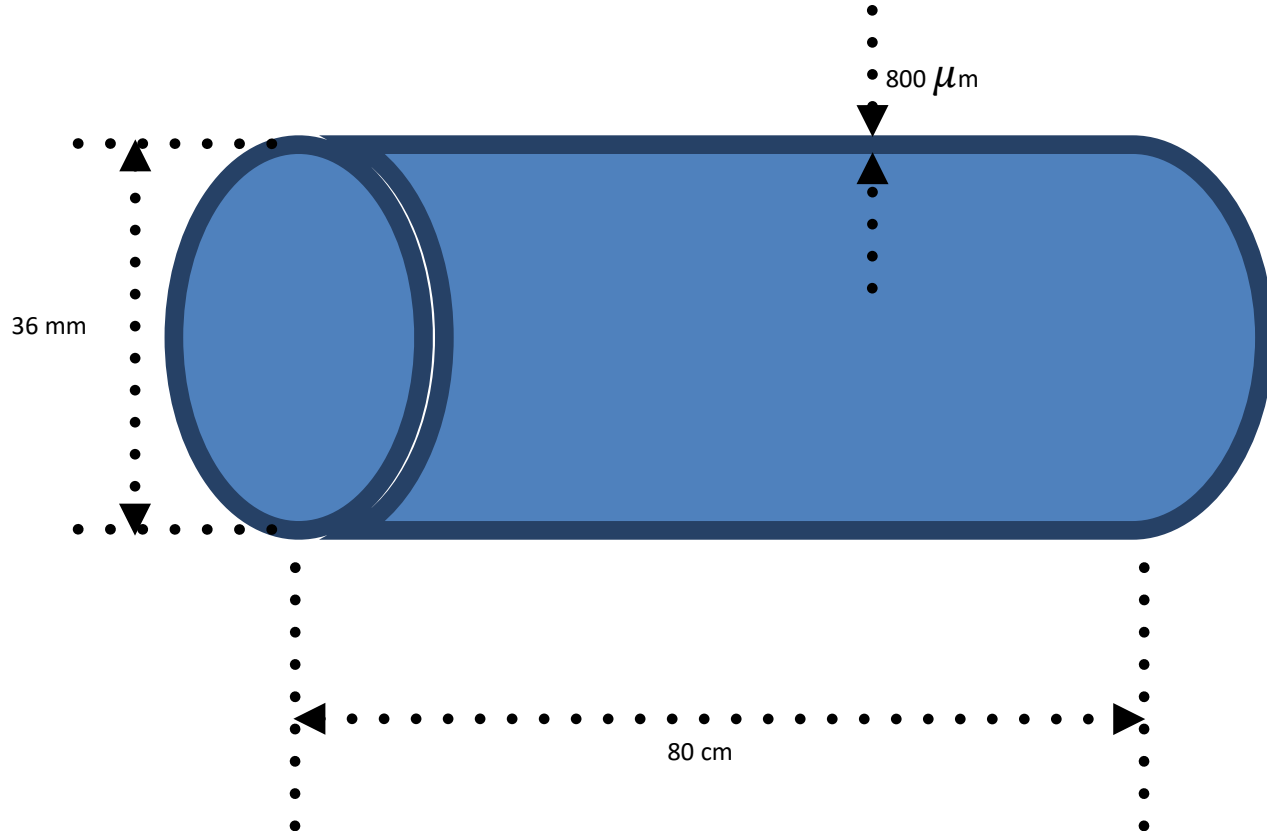
Disks



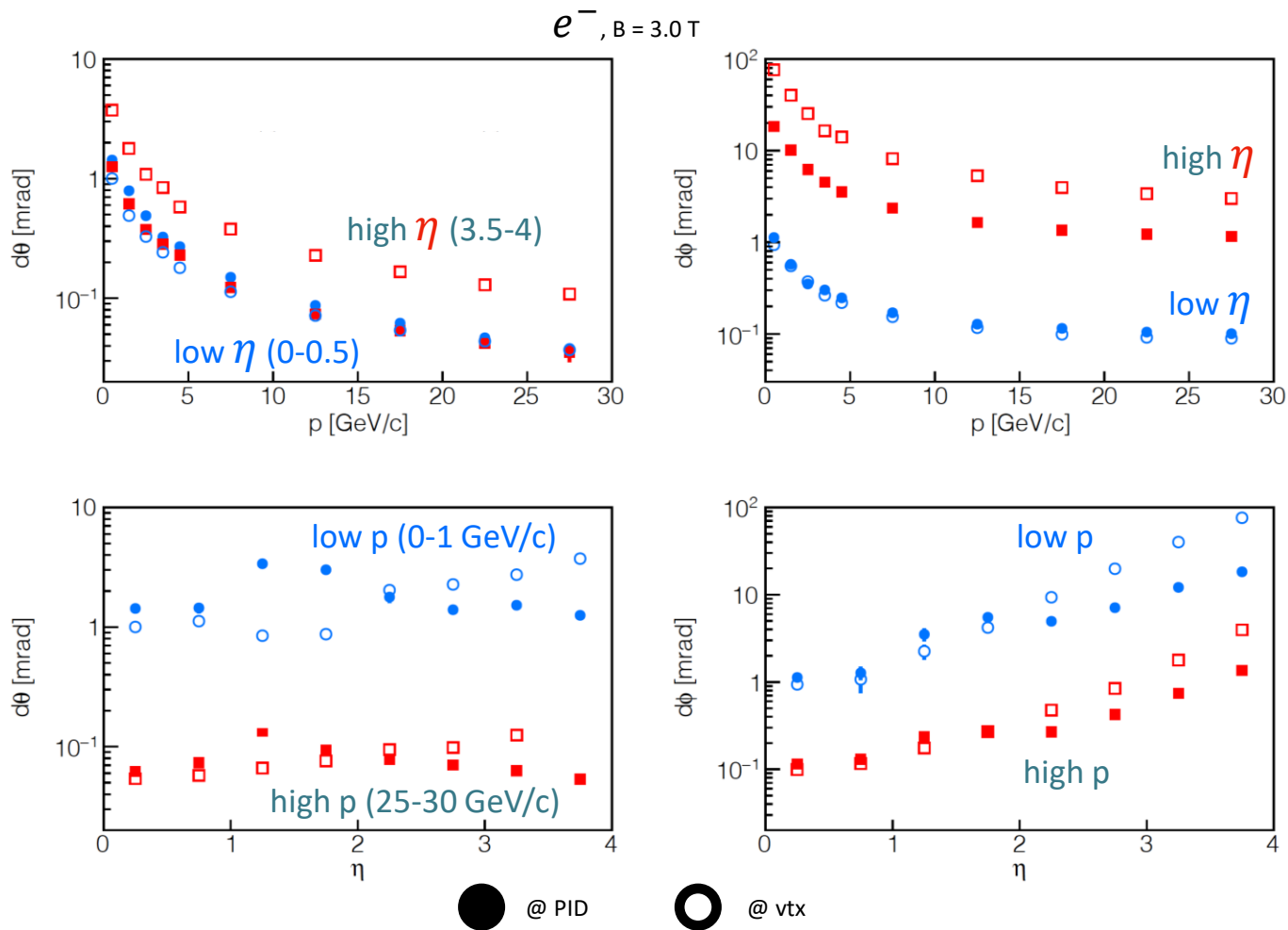
Aluminum Support Structure



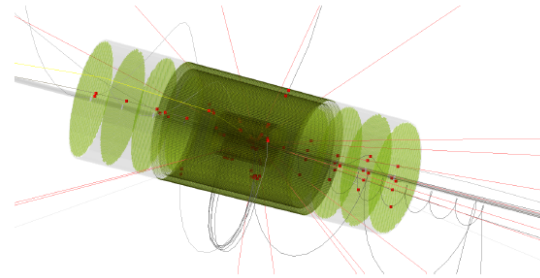
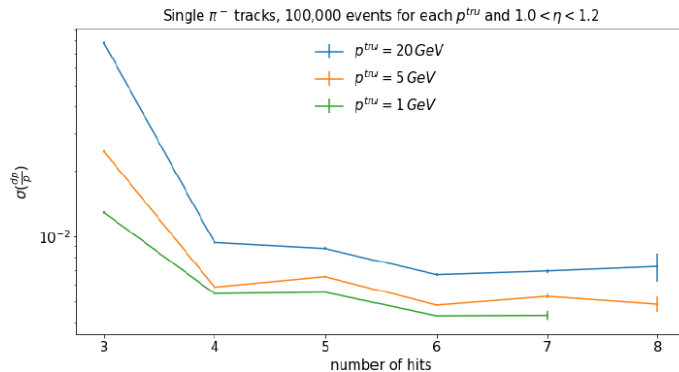
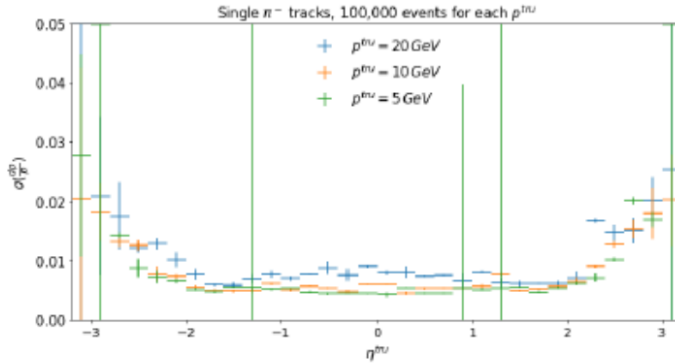
Beryllium beampipe



Comparison with vertex resolution



eRD16+ - recent simulations



Support and services (grey):

- simplified model,
- “along the cones”,
- uniform in azimuth

Studies of transition region,

- acceptance edges and gaps
- Single tracks to jets,
- Tracking robustness with dropped hits,

Transition(-ing) to Fun4All, Cori,

See Rey’s talk today (or next week)

Iteration to refine the concept.